

PRODUCT/PROCESS CHANGE NOTIFICATION

PCN MPA-MIC/06/2052 Notification Date 10/30/2006

ST72F60x & ST72F63Bx families design improvement

MIC - MICROCONTROLLERS

Table 1. Change Identification

Product Identification (Product Family/Commercial Product)	ST72F60x & ST72F63Bx families
Type of change	Product design change
Reason for change	Design modification to fix a functional limitation on pin PA2
Description of the change	Functionnality specified in the datasheet remains unchanged except the PA2 limitation described in the new Datasheet (see section "Known limitations" paragraph 16.1 page 139 of ST7263Bx datasheet and page 113 of ST7260x datasheet) has been fixed. This limitation on PA2 affects only rev B Flash devices only.
Product Line(s) and/or Part Number(s)	See attached
Description of the Qualification Plan	See attached
Change Product Identification	From revision B to revision W (see page 4)
Manufacturing Location(s)	

Table 2. Change Implementation Schedule

Forecasted implementation date for change	23-Jan-2007
Forecasted availabillity date of samples for customer	23-Oct-2006
Forecasted date for STMicroelectronics change Qualification Plan results availability	06-Nov-2006
Estimated date of changed product first shipment	23-Jan-2007

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Table 3. Change Responsibility

J. A. P. L.	Name	Signature	Date
Division Product Manager	J. Nicholas		Oct.23 ,06
Division Q.A. Manager	F. Demingo		Oct.23 ,06
Division Marketing Manager	Y. Benmokhtar		Oct.23 ,06

Table 4. List of Attachments

Customer Part numbers list	
Qualification Plan results	

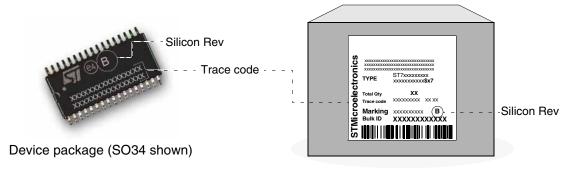
Customer Acknowledgement of Receipt	PCN MPA-MIC/06/2052
Please sign and return to STMicroelectronics	Sales Office Notification Date 10/30/2006
□ Qualification Plan Denied	Name:
□ Qualification Plan Approved	Title:
	Company:
□ Change Denied	Date:
□ Change Approved	Signature:
Remark	

A7/

Figure 83. Identifying Silicon Revision from Device Marking and Box Label

The silicon revision can be identified either by Rev letter or obtained via a trace code. Follow the procedure below:

- **1.** Identify the silicon revision letter from either the device package or the box label. For example, "**B**", etc.
- **2.** If the revision letter is not present, obtain the silicon revision by contacting your local ST office with the trace code information printed on either the box label or the device package.



Example box label

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